International Rectifier

IR25XB..H

25.0 Amps Single Phase Full Wave

Bridge Rectifier

Features

- Diode chips are glass passivated
- Suitable for Universal hole mounting
- Easy to assemble & install on P.C.B.
- High Surge Current Capability
- High Isolation between terminals and molded case (2500 V_{RMS})
- High Thermal Conductivity
- Lead free terminals solderable as per MIL-STD-750, Method 2026
- High Temperature soldering guaranteed at 260°C/ 8-10secs
- ULE160375 approved **Ş**

 $I_{O(AV)} = 25A$ $V_{RRM} = 200/800V$

Description

These IRXB..H Series of Single Phase Bridges consist of four glass passivated silicon junction connected as a Full Wave Bridge. These four junctions are encapsulated by plastic molding technique. These Bridges are mainly used in Switch Mode power supply, Induction cooker, Airconditioner, Washing Machine and Microwave oven.

Major Ratings and Characteristics

Parameters		IR25XBH	Units	
Io		25	А	
	@T _C	100	°C	
I _{FSM}	@50Hz	400	А	
	@60Hz	420	А	
I ² t	@50Hz	800	A ² s	
	@60Hz	732	A ² s	
V_{RRM}	range	200 to 800	V	
T _J		- 55 to 150	°C	



IR25XB..H

ELECTRICAL SPECIFICATIONS

Voltage Ratings

Type number	Voltage Code	V _{RRM} , max repetitive peak rev. voltage T _J = T _J max.	V _{RMS} , max RMS voltage T _J = T _J max.	V _{RSM} , max non-repetitive peak rev. voltage $T_J = T_J \max.$	I _{RRM} max. @ rated V _{RRM} T _J = 25°C µA	I _{RRM} max. @ rated V _{RRM} Τ _J = 150°C μΑ
IR25XBH	02 04	200 400	140 280	275 500	5	250 250
	06 08	600 800	420 560	725 900	5 5	250 250

Forward Conduction

	Parameters	IR25XBH	Unit	Conditions	
Io	Maximum DC output current	25	Α	$T_C = 100$ °C, Resistive & inductive load	
I _{FSM}	Maximum peak, one-cycle	400		t = 10ms	
	non-repetitive surge current,				
	following any rated load condition	420		t = 8.3ms	T _J =150°C
	and with rated V _{RRM} reapplied				
I ² t	Maximum I ² t for fusing,	800	A ² s	t = 10ms	
	initial T _J =T _J max	732		t = 8.3ms	
V _{FM}	Maximum peak forward voltage	0.975	V	T _J =25°C, I _{FM} =12.5	5A
	per diode				
I _{RM}	Typical peak reverse leakage	5.0	μA	T _J = 25°C, 100% \	/ _{RRM}
	current per diode	250		T _J =150°C, 100% V	/ RRM
V_{RRM}	Maximum repetitive peak	200 to 800	V		
	reverse voltage range				

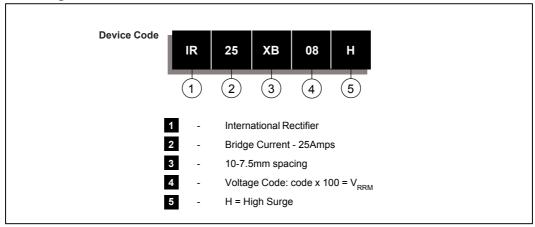
Thermal and Mechanical Specifications

	Parameters	IR25XBH	Unit	Conditions
T _J	Operating and storage	-55 to 150	°C	
T _{stg}	temperature range			
R _{thJC}	Max. thermal resistance	1.0	°C/W	At DC rated current (1)
	junction to case			
R _{thJA}	Thermal resistance,	22	°C/W	At DC rated current (2)
	junction to ambient			
W	Approximateweight	7.4 (0.26)	g(oz)	
Т	Mounting Torque	1.0	Nm	Bridge to Heatsink
		9.0	Lb.in	

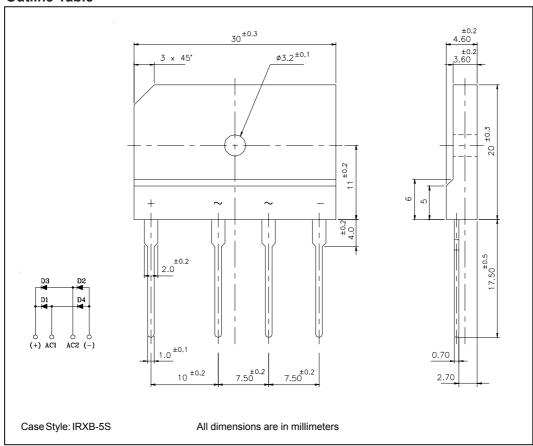
Note (1): Bridge mounted on Aluminun heat sink, use silicon thermal compound for heat transfer and bolt down using 3mm screw

 $(2): \ \ Bridges\, mounted\, in\, free\, air\, without\, heatsink.$

Ordering Information Table



Outline Table



Bulletin I27127 rev. D 06/03

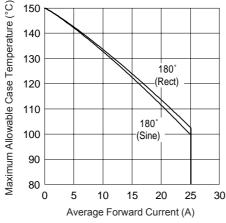
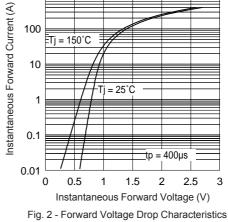


Fig. 1 - Current Ratings Characteristics



1000

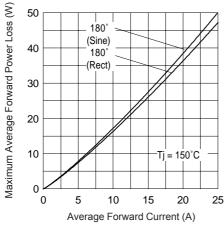


Fig. 3 - Total Power Loss Characteristics

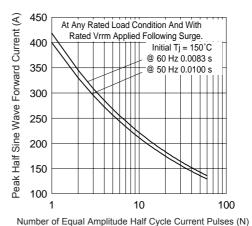


Fig. 4 - Maximum Non-Repetitive Surge Current

Data and specifications subject to change without notice. This product has been designed and qualified for Industrial and Consumer Level. Qualification Standards can be found on IR's Web site.



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